



January 6, 2026

**IGI Report Number LG763618654**  
**CUT CORNERED RECTANGULAR  
MODIFIED BRILLIANT**  
**LABORATORY GROWN DIAMOND**  
**7.31 X 4.95 X 3.21 MM**

Carat Weight	<b>0.95 CARAT</b>
Color Grade	<b>E</b>
Clarity Grade	<b>I.F.</b>
Cut Grade	<b>EXCELLENT</b>
Polish	<b>EXCELLENT</b>
Symmetry	<b>EXCELLENT</b>
Fluorescence	<b>NONE</b>
Inscription(s)	<b>IGI LG763618654</b>

Comments: As Grown - No indication of post-growth treatment. This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process. Type II

**LABORATORY GROWN DIAMOND REPORT**

January 6, 2026  
IGI Report Number **LG763618654**  
Description **LABORATORY GROWN DIAMOND**  
Shape and Cutting Style **CUT CORNERED RECTANGULAR MODIFIED BRILLIANT**  
Measurements **7.31 X 4.95 X 3.21 MM**

**GRADING RESULTS**

Carat Weight **0.95 CARAT**  
Color Grade **E**  
Clarity Grade **INTERNALLY FLAWLESS**  
Cut Grade **EXCELLENT**

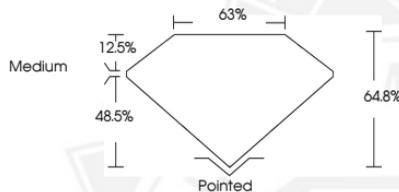
**ADDITIONAL GRADING INFORMATION**

Polish **EXCELLENT**  
Symmetry **EXCELLENT**  
Fluorescence **NONE**  
Inscription(s) **IGI LG763618654**

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Sample Image Used



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